

# XLamp® XP-LR LEDs



# **PRODUCT DESCRIPTION**

XLamp® XP-LR LEDs expand the XP-L · Available in 70-CRI white product family with a round, circular . light-emitting surface (LES) version that . improves the quality of projected light . through optics, compared to traditional . LEDs with a square LES. The bottom of . the XP-LR maintains the same dimensions . and footprint as all other XLamp XP LEDs, . so it is an easy upgrade path for XP-based • designs.

The compact and proven 3.45-mm XP platform has an excellent ecosystem of optics and system solutions available, enabling lighting manufacturers simplify their design process and shorten time-to-market.

XLamp XP-LR LEDs are optimized for directional portable lighting applications where the best possible beam quality is required.

#### **FEATURES**

- ANSI-compatible chromaticity bins
- Binned at 85 °C
- Maximum drive current: 6000 mA
- Low thermal resistance: 0.8 °C/W
- Wide viewing angle: 120°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C
- Electrically neutral thermal path
- RoHS and REACH compliant
- UL® recognized component (E349212)

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# **CHARACTERISTICS**

| Characteristics   | Unit    | Minimum | Typical  | Maximum |
|---|---------|---------|----------|---------|
| Thermal resistance, junction to solder point <sup>o</sup> | °C/W    |         | 0.8      |         |
| Viewing angle (FWHM)                                      | degrees |         | 120      |         |
| Temperature coefficient of voltage                        | mV/°C   |         | -1.4     |         |
| ESD withstand voltage (HBM per Mil-Std-883D)              |         |         | Class 3B |         |
| DC forward current (@ 85 °C)                              | mA      |         |          | 6000    |
| Reverse voltage   | V       |         |          | 5       |
| Forward voltage (@ 2000 mA, 85 °C)                        | V       |         | 3        | 3.2     |
| LED junction temperature                                  | °C      |         | 85       | 150     |

#### Note:

♦ Thermal resistance measurement was performed per the JEDEC JESD51-14 standard. See the Thermal Resistance Measurement application note for more details.



# FLUX CHARACTERISTICS (T<sub>J</sub> = 85 °C)

The following table provides order codes for XLamp XP-LR LEDs. For a complete description of the order code nomenclature, please see the Bin and Order Code Formats section (page 11). For definitions of the chromaticity kits, please see the Cree LED's Standard Chromaticity Kits section (page 9).

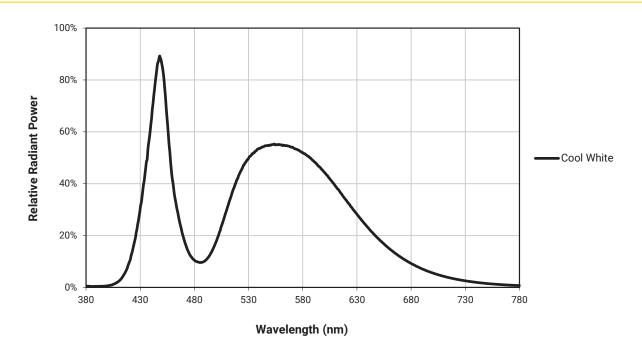
| Chromaticity |        | Minimum Luminous Flux (lm)<br>@ 2000 mA |                      |                      | Order Code               |  |
|--------------|--------|---|----------------------|----------------------|--------------------------|--|
| Kit          | сст    | Code                                    | Flux (lm)<br>@ 85 °C | Flux (lm)<br>@25 °C* |                          |  |
| E1           | 6500 K | F4                                      | 730                  | 808                  | XPLRWA-H0-0000-000BF40E1 |  |
| E2           | 5700 K | F4                                      | 730                  | 808                  | XPLRWA-H0-0000-000BF40E2 |  |
| E3           | 5000 K | F4                                      | 730                  | 808                  | XPLRWA-H0-0000-000BF40E3 |  |

### Notes

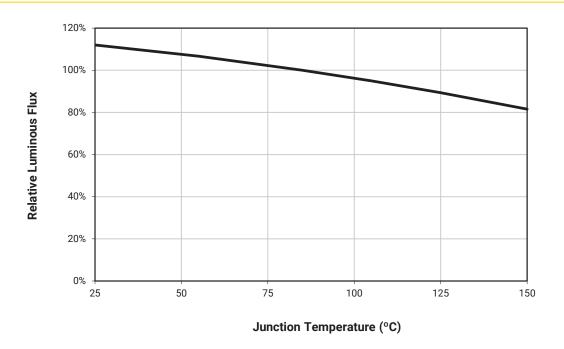
- Cree LED maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and a tolerance of ±2 on CRI measurements. See the Measurements section (page 12).
- XLamp XP-LR LED order codes specify only a minimum flux bin and not a maximum. Cree LED may ship reels in flux bins higher than the minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity bin restrictions specified by the order code.
- \* Flux values @ 25 °C are calculated and for reference only.



# **RELATIVE SPECTRAL POWER DISTRIBUTION**

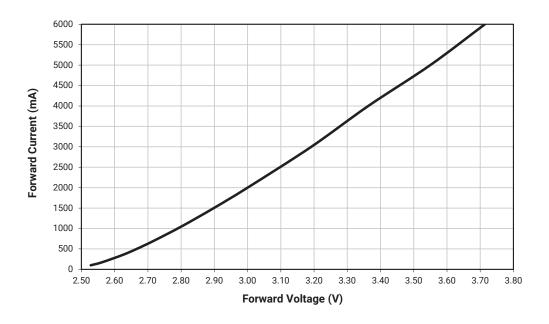


### **RELATIVE FLUX VS. JUNCTION TEMPERATURE**

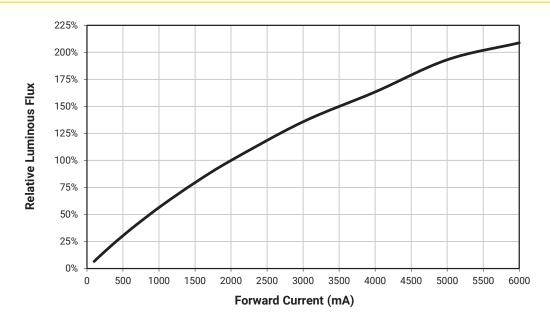




# **ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 85 °C)**

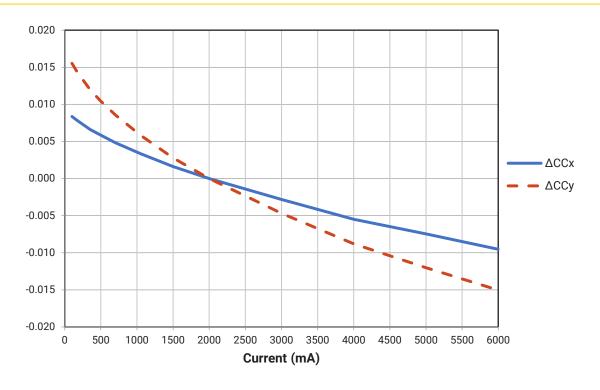


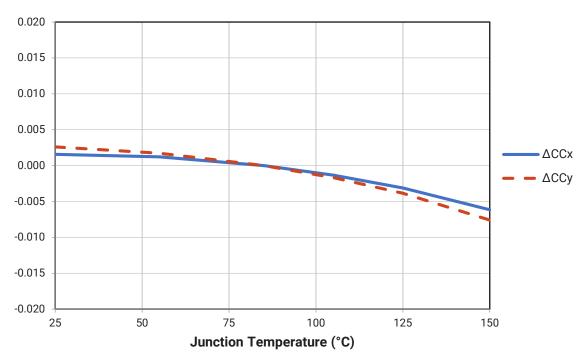
# **RELATIVE LUMINOUS FLUX VS. CURRENT (T<sub>J</sub> = 85 °C)**





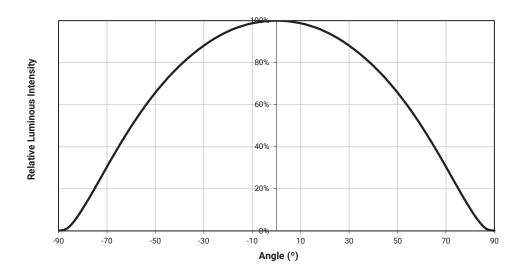
### **RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE**





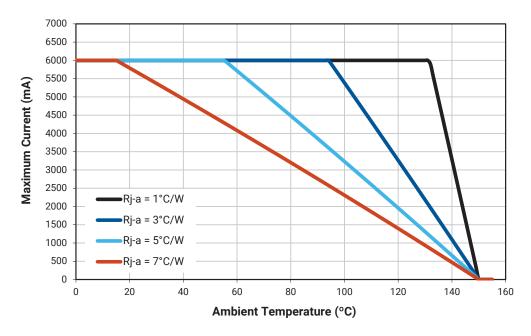


#### TYPICAL SPATIAL DISTRIBUTION



#### THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.





# **PERFORMANCE GROUPS - LUMINOUS FLUX**

XLamp XP-LR LEDs are tested for luminous flux and placed into one of the following luminous-flux groups.

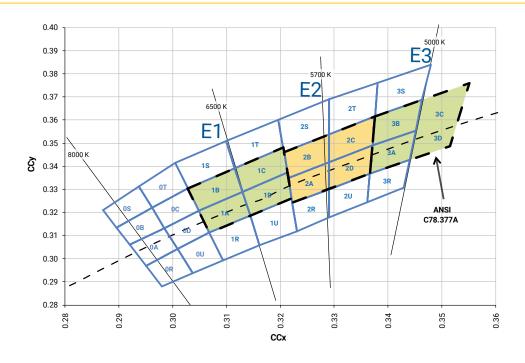
| Group Code | Minimum Luminous Flux (lm)<br>@ 2000 mA | Maximum Luminous Flux (lm)<br>@ 2000 mA |  |
|------------|---|---|--|
| F4         | 730                                     | 780                                     |  |
| G2         | 780                                     | 840                                     |  |

# **PERFORMANCE GROUPS - CHROMATICITY**

| Region | x      | у      | Region | x             | у      | Region        | x      | у      | Region | x      | у      |
|--------|--------|--------|--------|---------------|--------|---------------|--------|--------|--------|--------|--------|
|        | 0.3048 | 0.3207 |        | 0.3028        | 0.3304 |               | 0.3115 | 0.3391 |        | 0.3130 | 0.3290 |
| 1A     |        | 0.3115 | 0.3391 | 1C            | 0.3205 | 0.3481        | 1D     | 0.3213 | 0.3373 |        |        |
| IA     | 0.3144 | 0.3186 | 1B     | 0.3130        | 0.3290 | TC .          | 0.3213 | 0.3373 | U      | 0.3221 | 0.3261 |
|        | 0.3068 | 0.3113 |        | 0.3048        | 0.3207 |               | 0.3130 | 0.3290 |        | 0.3144 | 0.3186 |
|        | 0.3215 | 0.3350 |        | 0.3207        | 0.3462 | 538 2C<br>417 | 0.3290 | 0.3538 | 2D     | 0.3290 | 0.3417 |
| 2A     | 0.3290 | 0.3417 | 2B     | 0.3290        | 0.3538 |               | 0.3376 | 0.3616 |        | 0.3371 | 0.3490 |
| ZA     | 0.3290 | 0.3300 |        | 0.3290        | 0.3417 |               | 0.3371 | 0.3490 |        | 0.3366 | 0.3369 |
|        | 0.3222 | 0.3243 |        | 0.3215        | 0.3350 |               | 0.3290 | 0.3417 |        | 0.3290 | 0.3300 |
|        | 0.3371 | 0.3490 |        | 0.3376 0.3616 |        | 0.3463        | 0.3687 |        | 0.3451 | 0.3554 |        |
| 3A     | 0.3451 | 0.3554 | 3В     | 0.3463        | 0.3687 | 3C            | 0.3551 | 0.3760 | 3D     | 0.3533 | 0.3620 |
| 3A     | 0.3440 | 0.3427 |        | 0.3451        | 0.3554 |               | 0.3533 | 0.3620 |        | 0.3515 | 0.3487 |
|        | 0.3366 | 0.3369 |        | 0.3371        | 0.3490 |               | 0.3451 | 0.3554 |        | 0.3440 | 0.3427 |



#### CREE LED'S STANDARD COOL WHITE KITS PLOTTED ON ANSI STANDARD CHROMATICITY REGIONS



### **CREE LED'S STANDARD CHROMATICITY KITS**

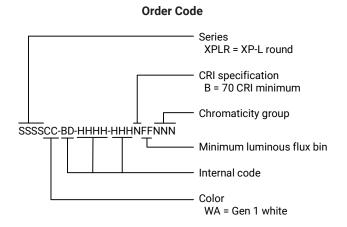
The following table provides the chromaticity bins associated with chromaticity kits.

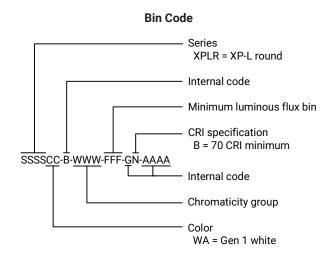
| Color         | ССТ    | Kit | Chromaticity Bins |
|---------------|--------|-----|-------------------|
|               | 6500 K | E1  | 1A, 1B, 1C, 1D    |
| Cool<br>White | 5700 K | E2  | 2A, 2B, 2C, 2D    |
|               | 5000 K | E3  | 3A, 3B, 3C, 3D    |



#### **BIN AND ORDER CODE FORMATS**

XP-LR bin codes and order codes are configured in the following manner:



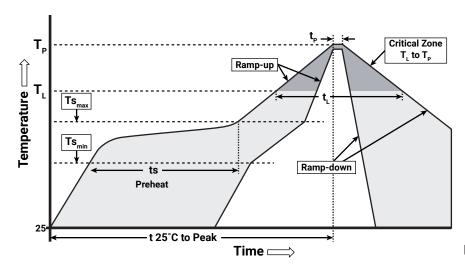




#### **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree LED has found XLamp XP-LR LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree LED recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer's responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

| Profile Feature   | Lead-Free Solder |
|---|------------------|
| Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)          | 1.2 °C/second    |
| Preheat: Temperature Min (Ts <sub>min</sub> )           | 120 °C           |
| Preheat: Temperature Max (Ts <sub>max</sub> )           | 170 °C           |
| Preheat: Time (Ts <sub>min</sub> to Ts <sub>max</sub> ) | 65-150 seconds   |
| Time Maintained Above: Temperature (T <sub>L</sub> )    | 217 °C           |
| Time Maintained Above: Time (t <sub>L</sub> )           | 45-90 seconds    |
| Peak/Classification Temperature (Tp)                    | 235 - 245 °C     |
| Time Within 5 °C of Actual Peak Temperature (tp)        | 20-40 seconds    |
| Ramp-Down Rate  | 1 - 6 °C/second  |
| Time 25 °C to Peak Temperature                          | 4 minutes max.   |

Note: All temperatures refer to the topside of the package, measured on the package body surface.



#### **NOTES**

#### Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree LED's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

#### **Pre-Release Qualification Testing**

Please read the LED Reliability Overview for details on the qualification testing performed on XP-LR LEDs.

#### **Moisture Sensitivity**

Cree LED recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-LR LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of  $\leq$  30 °C/85% relative humidity (RH). Regardless of the storage condition, Cree LED recommends sealing any unsoldered LEDs in the original MBP.

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

#### **REACH Compliance**

REACH substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree LED representative to insure you get the most up-to-date REACH Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

#### **UL® Recognized Component**

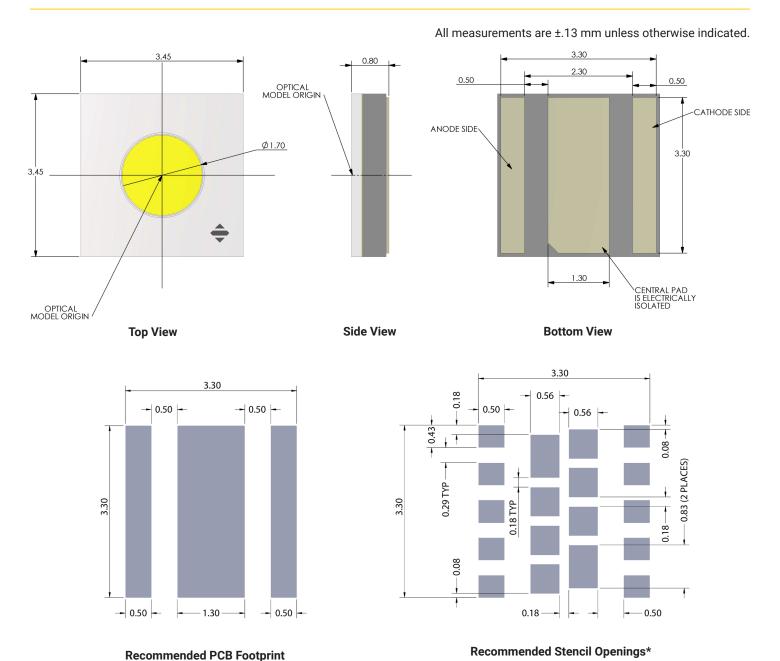
This product meets the requirements to be considered a UL Recognized Component with Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

#### **Vision Advisory**

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.



### **MECHANICAL DIMENSIONS**



#### Notes:

- Cree LED recommends using thermal pad kickouts to maximize component thermal performance.
- · Cree LED recommends using white solder mask material to minimize system optical loss.
- \* This stencil has been tested and optimized for the avoidance of voiding when using ALPHA® LUMET® P30 Maxrel solder paste. For other solder pastes, a "window pane" design for the thermal pad stencil may result in a lower voiding percentage. Contact your local Cree LED Field Applications Engineer for consultation regarding your specific application.

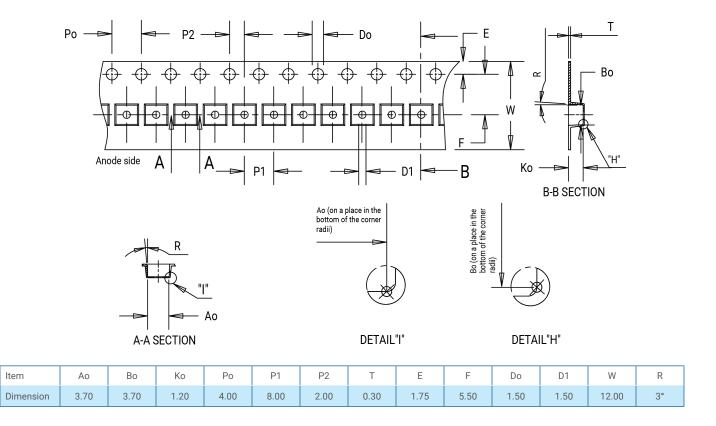


#### **TAPE AND REEL**

All Cree LED carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

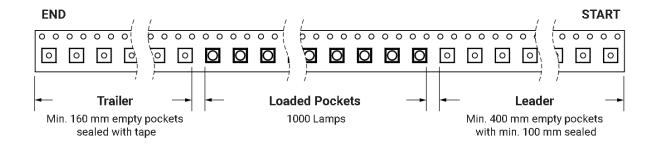
Except as noted, all dimensions in mm.

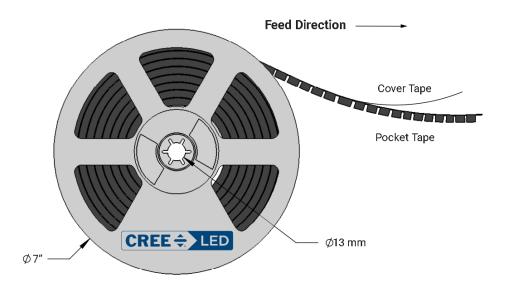
All measurements are ±0.15 mm unless otherwise indicated.





#### **TAPE AND REEL - CONTINUED**







#### **PACKAGING**

